

GPON ONU BOSA 1.25G 1310nmTX/2.5G 1490RX**Features:**

- ◆ Coaxial Package
- ◆ InGaAsP/InP MQW-DFB Laser Diode
- ◆ Low threshold, high slope efficiency and high output power
- ◆ Operating Case Temperature: -40°C to +85°C
- ◆ Single-mode fiber pigtailed with SC FC ST or LC connector
- ◆ High channel isolation
- ◆ Low return loss
- ◆ Optional with Isolator

**Applications:**

- ◆ GPON ONU side
- ◆ Long distance digital transmission system
- ◆ Cable television system
- ◆ WDM systems

Absolute Maximum Ratings:

| Parameter | Symbol | Min. | Max. | Unit |
|-------------------------------------|-----------------|------|--------|--------|
| Storage Temperature | Tstg | -40 | 100 | °C |
| Operating Case Temperature | Topr | -40 | 85 | °C |
| Reverse Voltage (LD) | V _{RL} | --- | 2 | V |
| Reverse Voltage (PD) | V _{RD} | --- | 20 | V |
| Photodiode Forward Current (PD) | I _{FD} | --- | 2 | mA |
| Forward Current(LD) | I _{FL} | --- | 150 | mA |
| Lead Soldering (Temperature)/(Time) | --- | --- | 260/10 | °C/Sec |

1.25G Transmitter Specifications:

Unless specified else, the specifications below are defined at TC=25±3°C

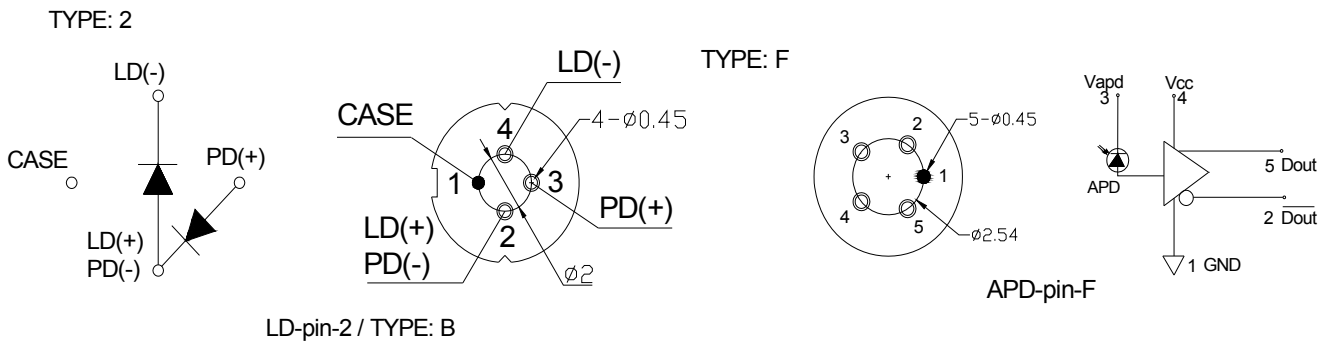
| Description | Symbol | Min. | Typ. | Max. | Unit | Condition |
|-----------------------------|--------------------------------|------|------|------|------|---|
| Threshold Current | I _{th} | --- | 6 | 15 | mA | at T _c =25°C |
| Output Optical Power | P _o | 1.8 | | 3.5 | mW | CW, I _{op} =I _{th} +20mA, |
| | | 1.0 | --- | --- | | CW, I _{op} =I _{th} +20mA, T _c =85°C |
| Peak Wavelength | λ | 1290 | 1310 | 1330 | nm | CW, I _{op} =I _{th} +20mA, T _c =-40~85°C |
| Operating Voltage | V _{op} | --- | 1.1 | 1.5 | V | at T _c =25°C |
| Side-mode Suppression Ratio | SMSR | 35 | 40 | --- | dB | CW, I _{op} =I _{th} +20mA, T _c =-40~85°C |
| Tracking error | TE | -1.5 | --- | 1.5 | dB | APC, -40°C/+25°C, +25°C/+85°C |
| Monitor Current | I _{mon} | 0.2 | 0.5 | 2.0 | mA | CW, I _{op} =I _{th} +20mA, |
| Monitor Dark Current | I _d | --- | --- | 0.1 | μA | VRD=5V |
| Rise/Fall Time | T _r /T _f | --- | 0.1 | 0.2 | ns | 20%~80% |

2.5G Receiver Specifications:

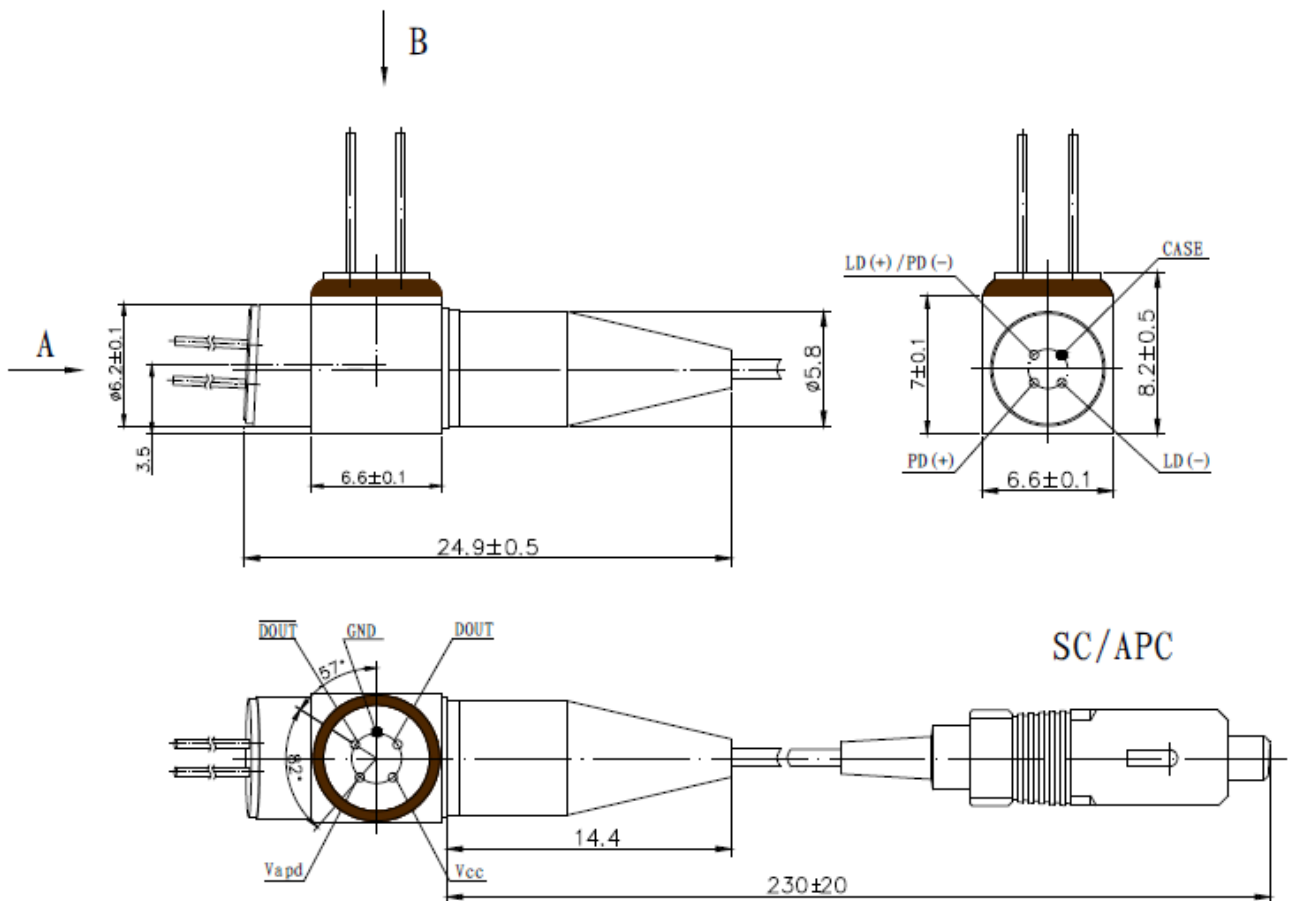
Unless specified else, the specifications below are defined at TC=25±3°C

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Conditions |
|--|------------------|------|------|------|------|---|
| Operating Wavelength | λ | 1480 | 1490 | 1500 | nm | --- |
| Voltage | V _{cc} | 3.0 | 3.3 | 3.6 | V | --- |
| Supply Current | I _{cc} | | 20 | 25 | mA | --- |
| APD Breakdown Voltage | V _{br} | 35 | 42 | 55 | V | --- |
| Overload | P _{in} | -8 | | | dBm | --- |
| Sensitivity | Sen | --- | --- | -31 | dBm | BER=10 ⁻¹⁰ @2.5G PRBS2 ²³ -1 |
| Optical Isolation from External Source | ISO1 | 25 | --- | --- | dB | λ=1441~1450nm λ=1530~1539nm |
| | ISO2 | 35 | --- | --- | dB | λ=1260~1440nm λ=1540~1625nm |
| Optical Return Loss | RL | 12 | --- | --- | dB | λ=1310nm |
| | | 20 | --- | --- | dB | λ=1490nm |
| Optical Crosstalk from Internal Laser | X _{opt} | --- | --- | -40 | dB | --- |

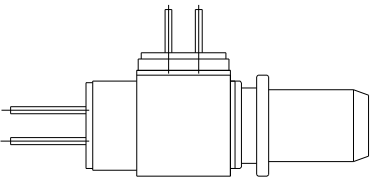
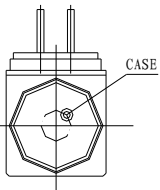
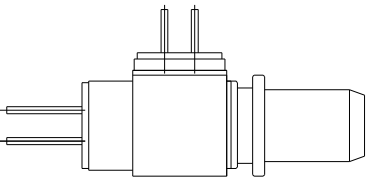
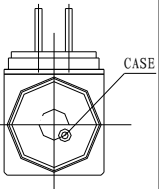
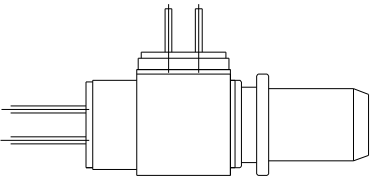
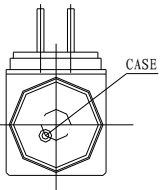
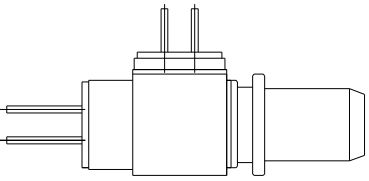
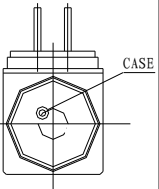
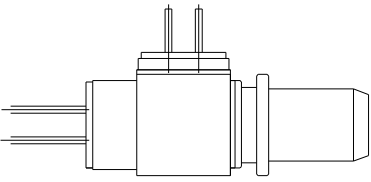
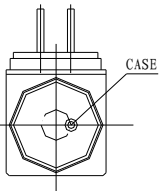
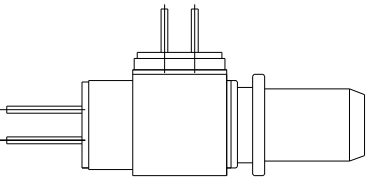
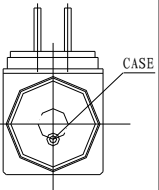
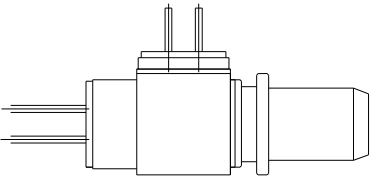
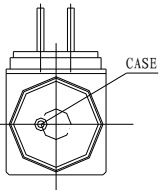
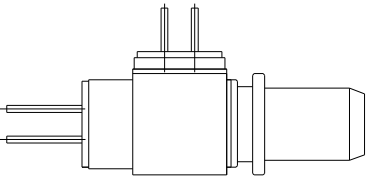
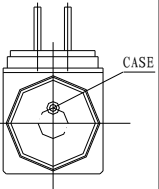
Pin Assignment:



Pigtail Package Series:



TX Pin Order Code *Note1. 2. 3

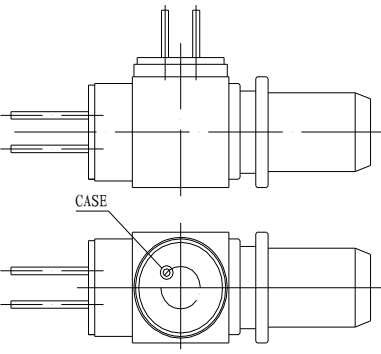
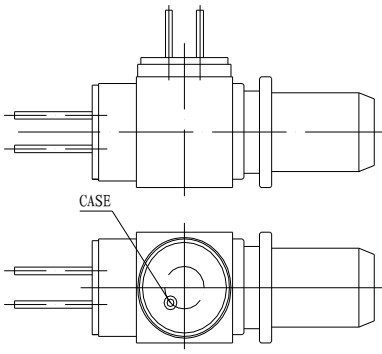
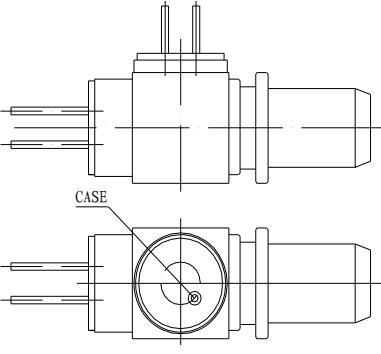
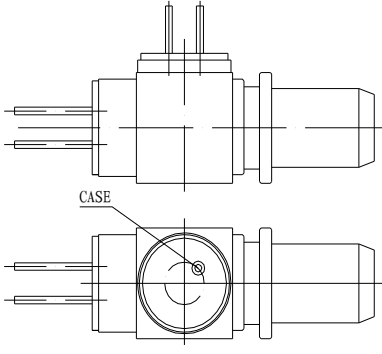
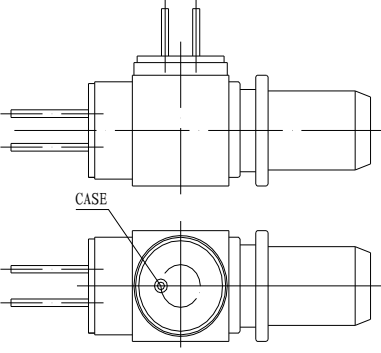
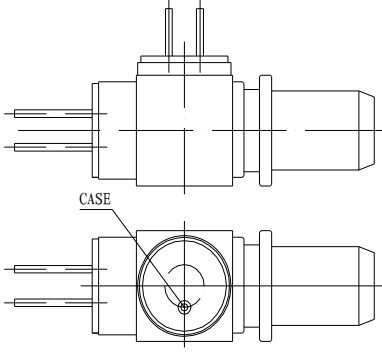
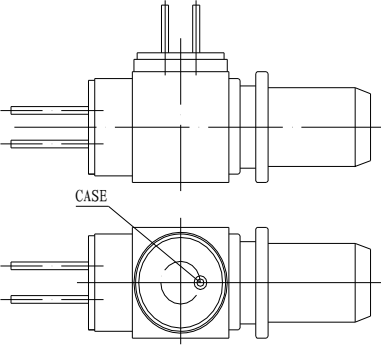
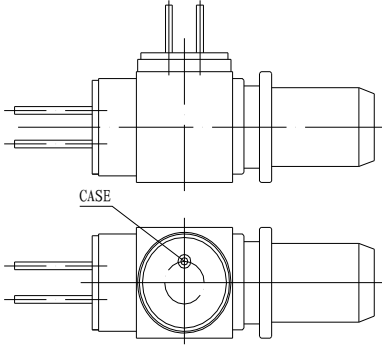
| Launch | | | |
|---|---|--|---|
|  |  |  |  |
| Case direction | A Type | Case direction | B Type |
|  |  |  |  |
| Case direction | C Type | Case direction | D Type |
|  |  |  |  |
| Case direction | E Type | Case direction | F Type |
|  |  |  |  |
| Case direction | G Type | Case direction | H Type |

Note1、 This picture is for pluggable, pigtail BIDI chip PIN package direction's reference.

Note2、 This picture is suitable for RX Pin direction comparison .

Note3、 The package direction is described as "x-x" For example "A-B", "A" is TX chip Pin direction, "B" is RX chip Pin direction.

RX Pin Order Code:

| Receive | | | |
|---|--------|--|--------|
|  | |  | |
| Case direction | A Type | Case direction | B Type |
|  | |  | |
| Case direction | C Type | Case direction | D Type |
|  | |  | |
| Case direction | E Type | Case direction | F Type |
|  | |  | |
| Case direction | G Type | Case direction | H Type |

Nomenclature:

HEBIDI-
A B C D E F G H I J K L M N O

| Code | Parameter | Detailed Description | | | | | | | |
|------|----------------------------|----------------------|---------------|------------|------------|----------------|---|---|---|
| A | Laser Type | BLANK=FP LD | | | | D=DFB LD | | | |
| B | Launch Wavelength | 3=1310nm | | | | | | | |
| C | Launch Data Rate | 1=1.25G | | | | 2=2.5G | | | |
| D | Output Power | 15=1~1.59mW | 25=1.6~2.99mW | 35=3~5 | XX=Custom | | | | |
| E | TX Pin Type | 1=LD-pin-1 | | | | Blank=LD-pin-2 | | | |
| F | Receiver Wavelength | L=1490nm | | | | | | | |
| G | Receiver Data Rate | 7=1.25G | | | | 9=2.5G | | | |
| H | Receiver Voltage | 3=3V | | | | | | | |
| I | RX Pin Type | F= pin-F | | | | | | | |
| J | Connector | F=FC/PC | S= SC/PC | T=ST/PC | N =None | | | | |
| | | FA=FC/APC | | SA= SC/APC | | L=LC/PC | | | |
| K | TX Pin Package Direction | A | B | C | D | E | F | G | H |
| L | TX Pin Package Direction | A | B | C | D | E | F | G | H |
| M | RX TO Insulated With Shell | Blank=NO Insulation | | | | J=Insulation | | | |
| N | Isolator | Blank=None | | | | G=with I | | | |
| O | Fibre length | Blank=50cm | 035=35cm | 100=100cm | XXX=Custom | | | | |

Precaution:

- (1) The modules should be handled in the same manner as ordinary semiconductor devices to prevent the electro-static damages. For safe keeping and carrying, the modules should be packaged with ESD proof material. To assemble the modules on PCB, the workbench, the soldering iron and the human body should be grounded.
- (2) Please pay special attention to the atmosphere condition because the dew on the module may cause some electrical damages.
- (3) Under such a strong vibration environment as in automobile, the performance and reliability are not guaranteed.

Notice:

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